



# **BAV3004W**

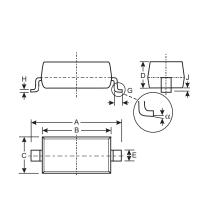
## SURFACE MOUNT LOW LEAKAGE DIODE

### Features

- Surface Mount Package Ideally Suited for Automatic Insertion
- Low Leakage Current
- Fast Switching Speed
- High Reverse Breakdown Voltage
- Lead Free/RoHS Compliant (Note 1)
- Qualified to AEC-Q101 Standards for High Reliability

## **Mechanical Data**

- Case: SOD-123
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free plating (Matte Tin Finish annealed over Alloy 42 leadframe)
- Polarity: Cathode Band
- Marking: Date Code and Type Code, See Page 2
- Type Code: 4P
- Ordering Information, See Page 2
- Weight: 0.01 grams (approximate)



SOD-123							
Dim	Min	Max					
Α	3.55	3.85					
В	2.55 2.85						
С	1.40 1.70						
D	—	1.35					
Е	0.45	0.65					
E	0.55 Typical						
G	0.25 —						
н	0.11 Typical						
J	_	0.10					
α	0°	8°					
All Dimensions in mm							

#### Maximum Ratings @ T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit		
Peak Repetitive Reverse Voltage	V <sub>RRM</sub>	350	V		
Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RWM</sub> V <sub>R</sub>				
RMS Reverse Voltage	V <sub>R(RMS)</sub>	212	V		
Forward Continuous Current	I <sub>FM</sub>	225	mA		
Repetitive Peak Forward Current	I <sub>FRM</sub>	625	mA		
Non-Repetitive Peak Forward Surge Current @ $t = 1.0 \mu s$ @ $t = 1.0 \mu s$	I <sub>FSM</sub>	4.0 1.0	A		

## **Thermal Characteristics**

Characteristic	Symbol	Value	Unit		
Power Dissipation (Note 3)	Pd	400	mW		
Thermal Resistance Junction to Ambient Air (Note 3)	$R_{ ext{ heta}JA}$	312	°C/W		
Operating and Storage Temperature Range	Тј, Т <sub>STG</sub>	-65 to +150	°C		

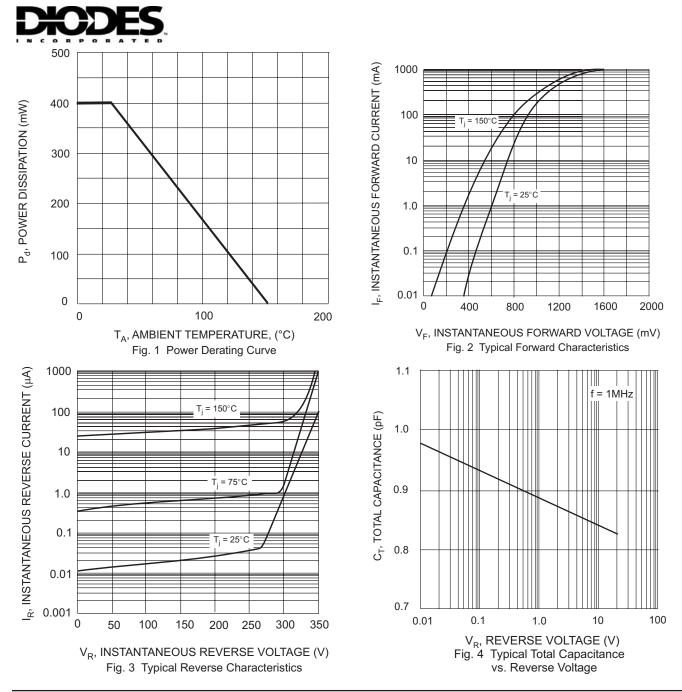
#### **Electrical Characteristics** @ $T_A = 25^{\circ}C$ unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 2)	V <sub>(BR)R</sub>	350			V	$I_{R} = 150 \mu A$
Forward Voltage	V <sub>FM</sub>	_	0.78 0.93 1.03	0.87 1.0 1.25	V	$I_F = 20 \text{mA}$ $I_F = 100 \text{mA}$ $I_F = 200 \text{mA}$
Leakage Current (Note 2)	I <sub>RM</sub>		30 35	100 100	nA μA	$V_R = 240V, T_j = 25^{\circ}C$ $V_R = 240V, T_j = 150^{\circ}C$
Total Capacitance	Ст		1.0	5.0	pF	V <sub>R</sub> = 0, f = 1.0MHz
Reverse Recovery Time	t <sub>rr</sub>		_	50	ns	$\label{eq:IF} \begin{array}{l} I_F = I_R = 30 m A, \\ I_{rr} = 3.0 m A, \ R_L = 100 \Omega \end{array}$

Notes: 1. No purposefully added lead.

2. Short duration pulse test used to minimize self-heating effect.

 Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf. T<sub>A</sub> = 25°C.



#### Ordering Information (Note 3)

Device	Packaging	Shipping		
BAV3004W-7-F	SOD-123	3000/Tape & Reel		

Notes: 3. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

## **Marking Information**

<b>4</b> P	ΥM	4 Y Y
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4P = Product Type Marking Code YM = Date Code Marking Y = Year (ex: T = 2006)

M = Month (ex: 9 = September)

Date Code Key												
Year		2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012
Code		N	Р	R	S	Т	U	V	W	Х	Y	Z
Month	Jan	Feb	March	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



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